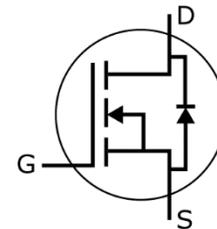
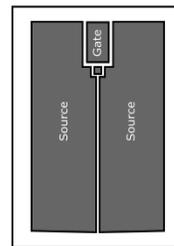


CPM3-3300-R050A

Wolfspeed SiC Gen3 MOSFET

Description

This is Wolfspeed's 3rd generation high-performance silicon carbide MOSFET in a package-less bare die format to be implemented into any custom module design.



G - Gate
S - Source
D - Drain

Package Type: Bare Die
PN: CPM3-3300-R050A

Features

- Enhanced 3rd Generation SiC MOSFET
- High blocking voltage with low on-resistance
- Easy to parallel and simple to drive
- Temperature-independent high-speed switching
- Integrated lumped gate resistance

Typical Applications

- Medium-voltage motor drives
- Renewable energy
- Smart grid/grid-tie power generation
- Pulsed-power applications
- Rail traction

Absolute Maximum Ratings

Stress beyond those listed under absolute maximum ratings may damage the device.

| Parameter | Symbol | Rating | Unit |
|---|-------------------|----------------|------|
| Drain-Source Voltage, across T_{VJ} | $V_{DS(max)}$ | 3300 | V |
| Maximum Gate-Source Voltage, Peak Transient Capability | $V_{GS(max)}$ | -10/+20 | V |
| Continuous Drain Current, $V_{GS} = 15$ V, assumes die packaged with typical $R_{th(j-c)} = 0.41$ K/W | I_{DS} | $T_c = 25$ °C | 52 |
| | | $T_c = 100$ °C | 36 |
| Pulsed Drain Current, t_p limited by $T_{VJ(max)}$ | $I_{DS(pulse)}$ | 104 | A |
| Virtual Junction and Storage Temperature | T_{VJ}, T_{stg} | -55 to +175 | °C |
| Maximum Processing Temperature, in non-reactive ambient | T_{proc} | 325 | °C |

Recommended Operating Conditions

| Parameter | Symbol | Rating | Unit |
|---|--------------|--------|------|
| Recommended Operating Gate-Source Voltage | $V_{GS(op)}$ | -5/+15 | V |



Electrical Characteristics ($T_{VJ} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

| Characteristics | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
|----------------------------------|---------------|------|------|------|---------------|--|
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | 3300 | | | V | $V_{GS} = 0\text{ V}, I_{DS} = 100\text{ }\mu\text{A}$ |
| Gate Threshold Voltage | $V_{GS(th)}$ | 2.6 | 3.5 | 4.4 | V | $V_{DS} = V_{GS}, I_{DS} = 26.5\text{ mA}$ |
| | | | 2.6 | | V | $V_{DS} = V_{GS}, I_{DS} = 26.5\text{ mA}, T_{VJ} = 175\text{ }^{\circ}\text{C}$ |
| Zero Gate Voltage Drain Current | I_{DSS} | | 5 | 30 | μA | $V_{DS} = 3300\text{ V}, V_{GS} = 0\text{ V}$ |
| Gate-Source Leakage Current | I_{GSS} | | 10 | 250 | nA | $V_{GS} = 15\text{ V}, V_{DS} = 0\text{ V}$ |
| Drain-Source On-State Resistance | $R_{DS(on)}$ | | 53 | 69 | m Ω | $V_{GS} = 15\text{ V}, I_{DS} = 40\text{ A}$ |
| | | | 136 | | | $V_{GS} = 15\text{ V}, I_{DS} = 40\text{ A}, T_{VJ} = 175\text{ }^{\circ}\text{C}$ |
| Transconductance | g_{fs} | | 26 | | S | $V_{DS} = 20\text{ V}, I_{DS} = 40\text{ A}$ |
| | | | 27 | | | $V_{DS} = 20\text{ V}, I_{DS} = 40\text{ A}, T_{VJ} = 175\text{ }^{\circ}\text{C}$ |
| Input Capacitance | C_{iss} | | 7240 | | pF | $V_{GS} = 0\text{ V}, V_{DS} = 1800\text{ V}$ $f = 100\text{ kHz}$ $V_{AC} = 25\text{ mV}$ |
| Output Capacitance | C_{oss} | | 100 | | | |
| Reverse Transfer Capacitance | C_{rss} | | 6 | | | |
| C_{oss} Stored Energy | E_{oss} | | 210 | | μJ | $V_{DS} = 1800\text{ V}, f = 100\text{ kHz}$ |
| Internal Gate Resistance | $R_{G(int)}$ | | 8.8 | | Ω | $f = 100\text{ kHz}, V_{AC} = 25\text{ mV}$ |
| Gate to Source Charge | Q_{gs} | | 131 | | nC | $V_{DS} = 2000\text{ V}, V_{GS} = -5\text{ V}/+15\text{ V}$ $I_{DS} = 50\text{ A}$ |
| Gate to Drain Charge | Q_{gd} | | 19 | | | |
| Total Gate Charge | Q_g | | 255 | | | |

Reverse Diode Characteristics ($T_{VJ} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

| Characteristics | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
|-------------------------------|-----------|------|------|------|------|--|
| Diode Forward Voltage | V_{SD} | | 4.9 | | V | $V_{GS} = -5\text{ V}, I_{SD} = 20\text{ A}$ |
| | | | 4.1 | | V | $V_{GS} = -5\text{ V}, I_{SD} = 20\text{ A}, T_{VJ} = 175\text{ }^{\circ}\text{C}$ |
| Reverse Recovery Time | t_{rr} | | 126 | | ns | $V_{GS} = -5\text{ V}, I_{SD} = 40\text{ A}, V_R = 1800\text{ V};$ $di_f/dt = 700\text{ A}/\mu\text{s}, T_{VJ} = 175\text{ }^{\circ}\text{C}$ |
| Reverse Recovery Charge | Q_{rr} | | 2970 | | nC | |
| Peak Reverse Recovery Current | I_{rrm} | | 47 | | A | |



Typical Performance

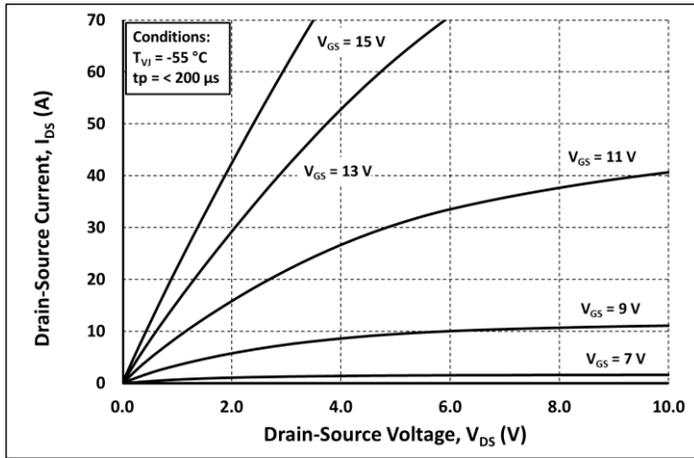


Figure 1.

Output Characteristics at $T_{VJ} = -55\text{ }^{\circ}\text{C}$

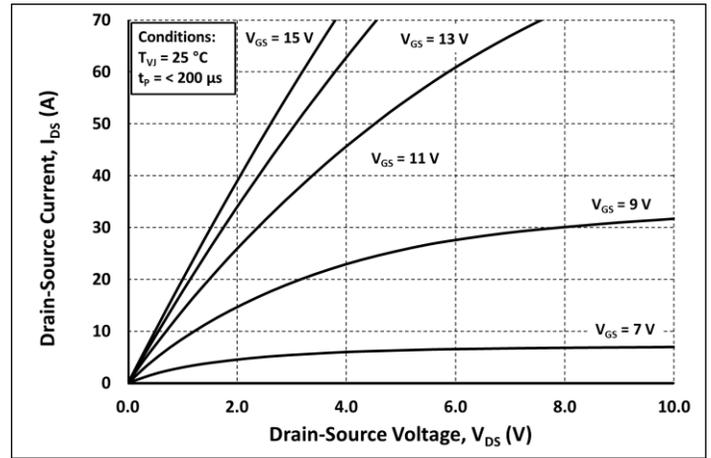


Figure 2.

Output Characteristics at $T_{VJ} = 25\text{ }^{\circ}\text{C}$

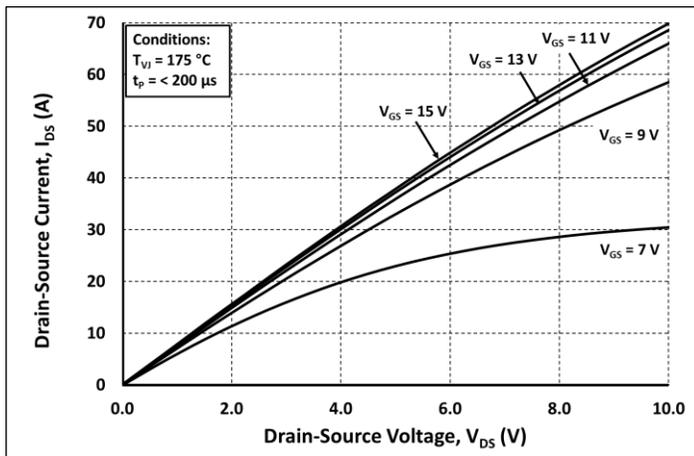


Figure 3.

Output Characteristics at $T_{VJ} = 175\text{ }^{\circ}\text{C}$

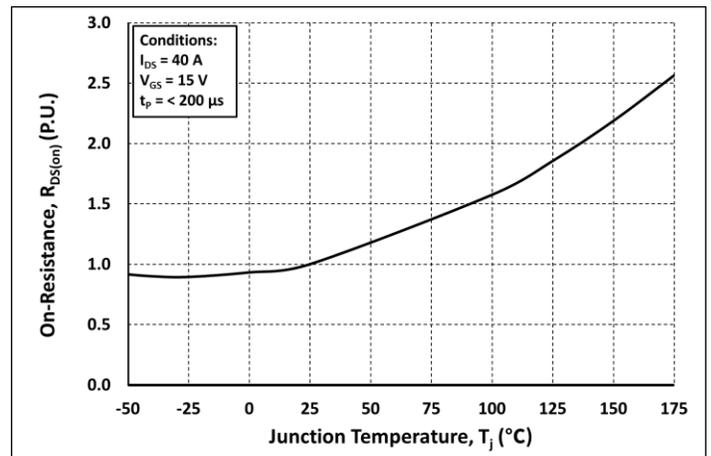


Figure 4.

Normalized On-Resistance vs. Temperature

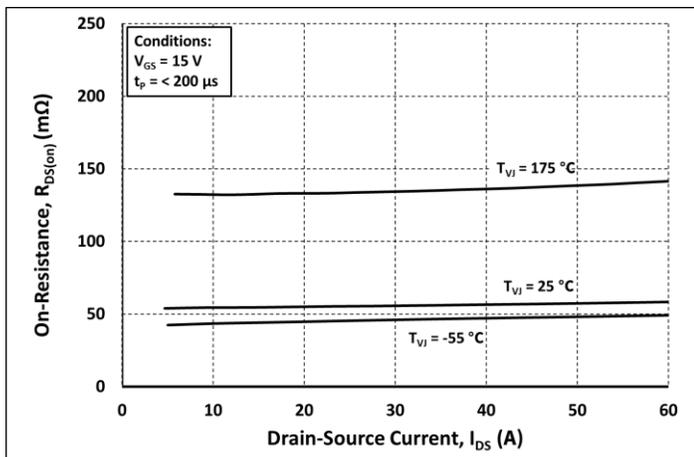


Figure 5.

On-Resistance vs. Drain Current for Various Temperatures

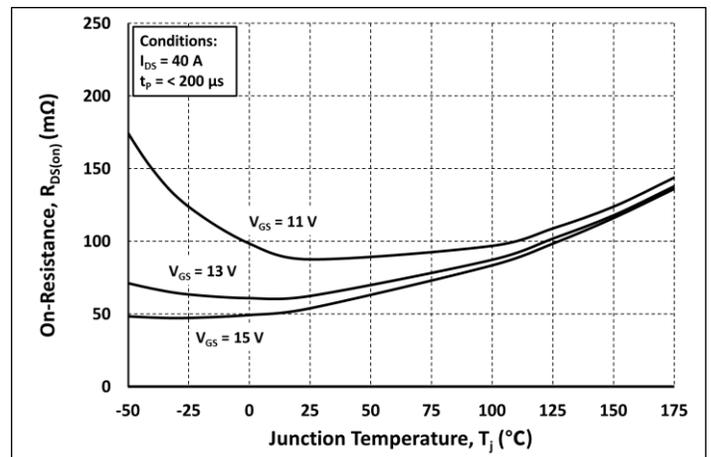


Figure 6.

On-Resistance vs. Temperature for Various Gate Voltages



Typical Performance

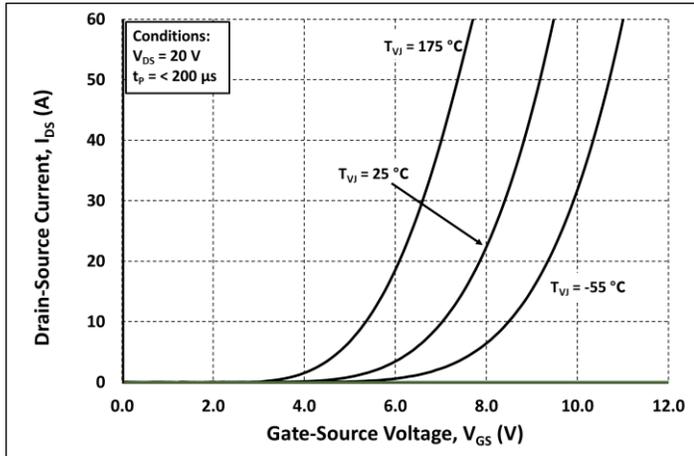


Figure 7.

Transfer Characteristic for Various Junction Temperatures

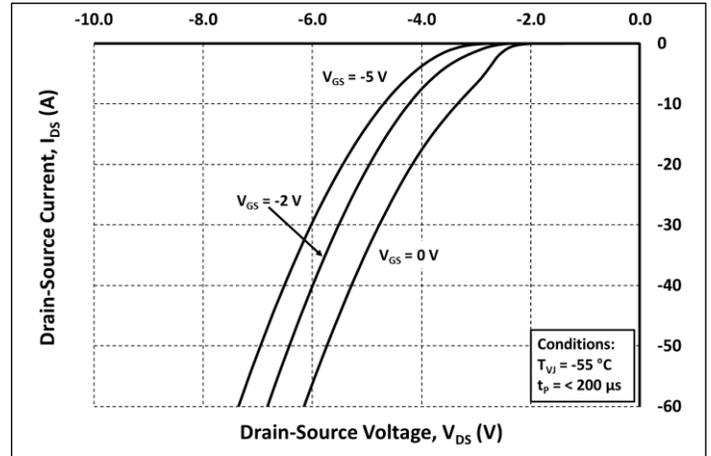


Figure 8.

Body Diode Characteristics at $T_{VJ} = -55\text{ }^{\circ}\text{C}$

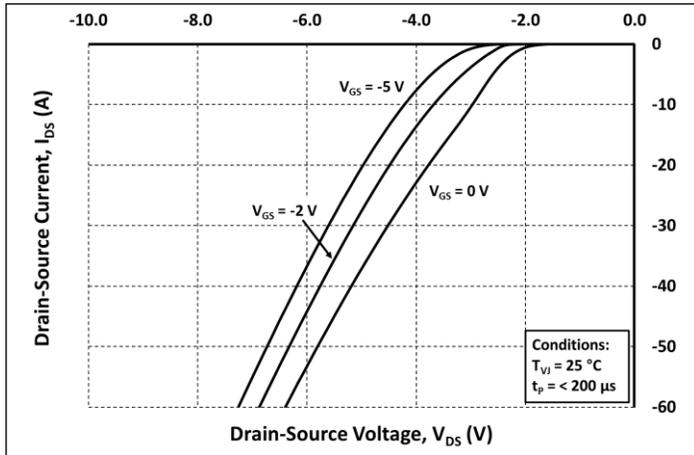


Figure 9.

Body Diode Characteristics at $T_{VJ} = 25\text{ }^{\circ}\text{C}$

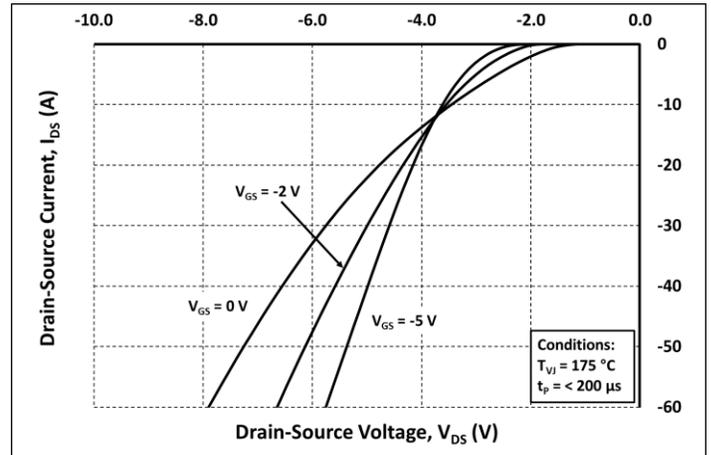


Figure 10.

Body Diode Characteristics at $T_{VJ} = 175\text{ }^{\circ}\text{C}$

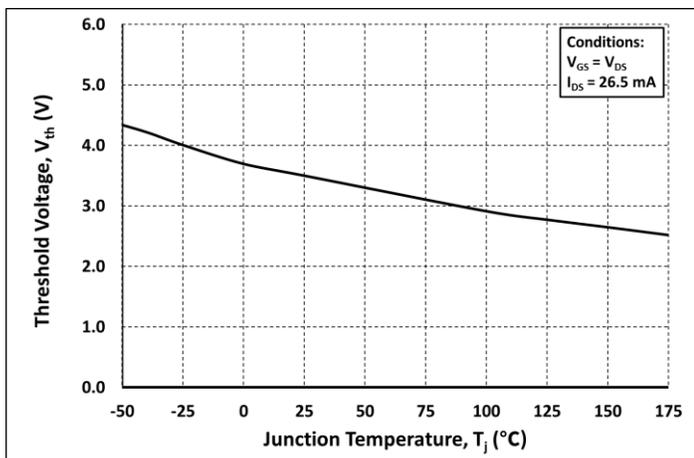


Figure 11.

Threshold Voltage vs. Temperature

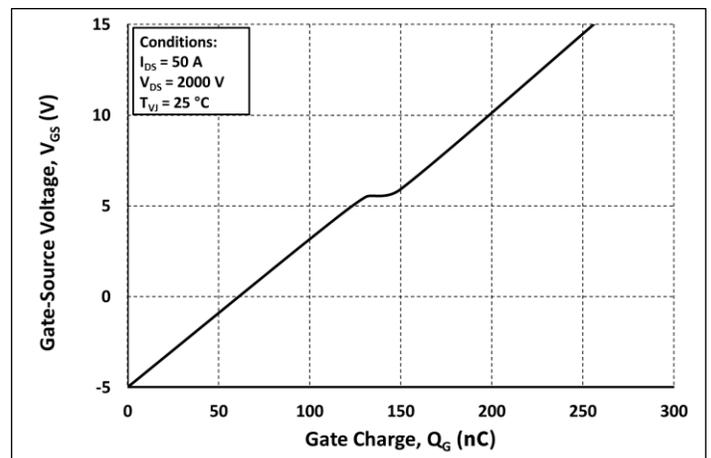


Figure 12.

Gate Charge Characteristic



Typical Performance

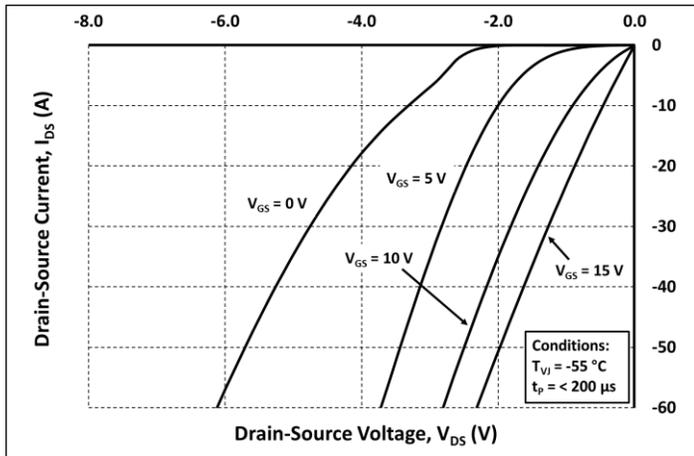


Figure 13.

3rd Quadrant Characteristics at $T_{VJ} = -55\text{ }^{\circ}\text{C}$

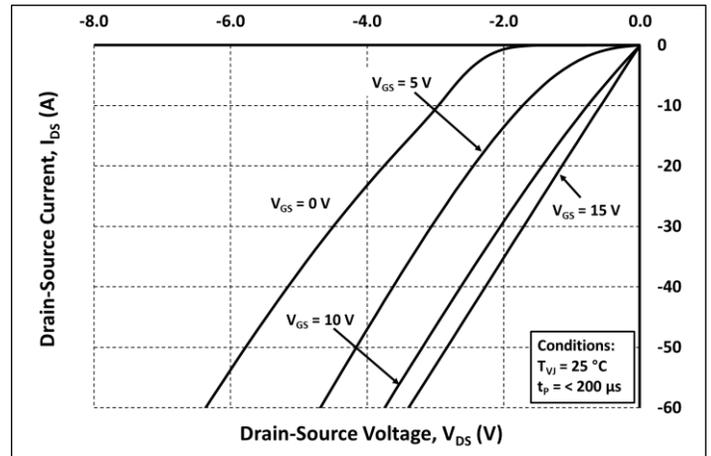


Figure 14.

3rd Quadrant Characteristics at $T_{VJ} = 25\text{ }^{\circ}\text{C}$

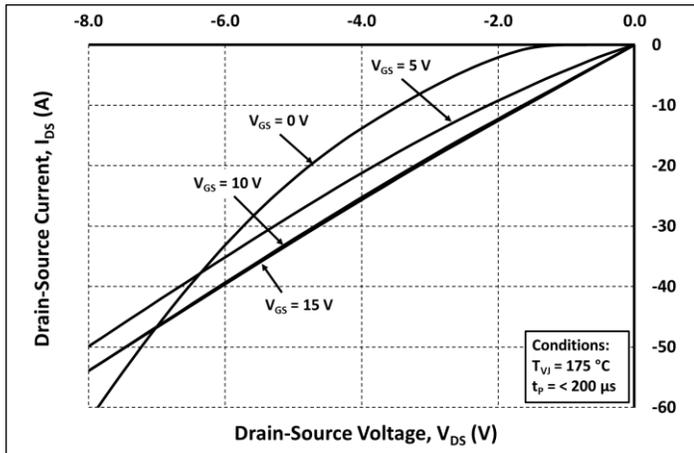


Figure 15.

3rd Quadrant Characteristics at $T_{VJ} = 175\text{ }^{\circ}\text{C}$

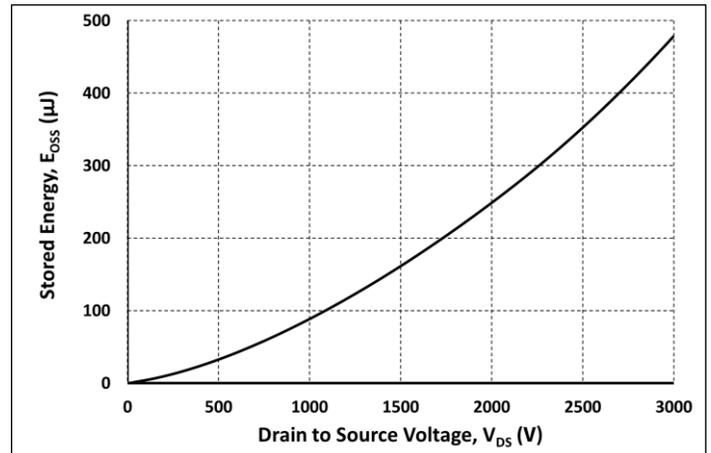


Figure 16.

Output Capacitor Stored Energy

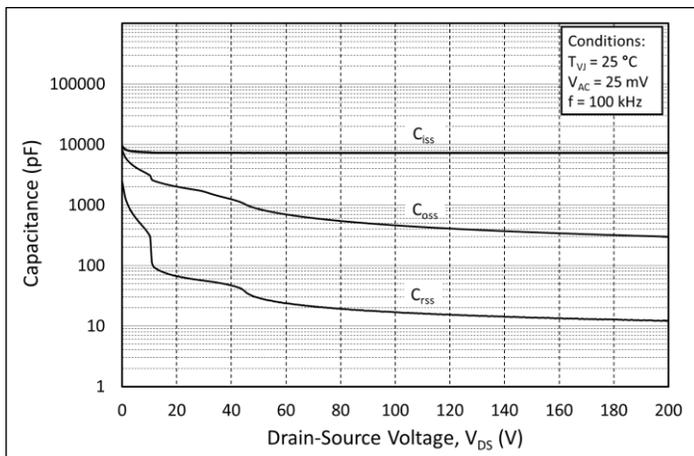


Figure 17.

Capacitances vs. Drain-Source Voltage (0 - 200 V)

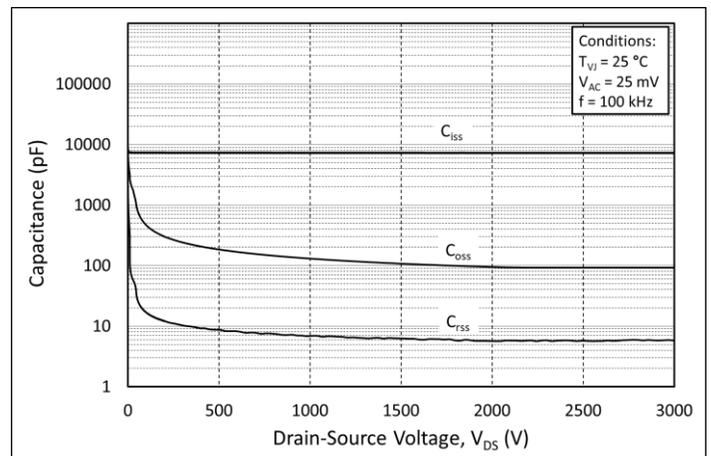


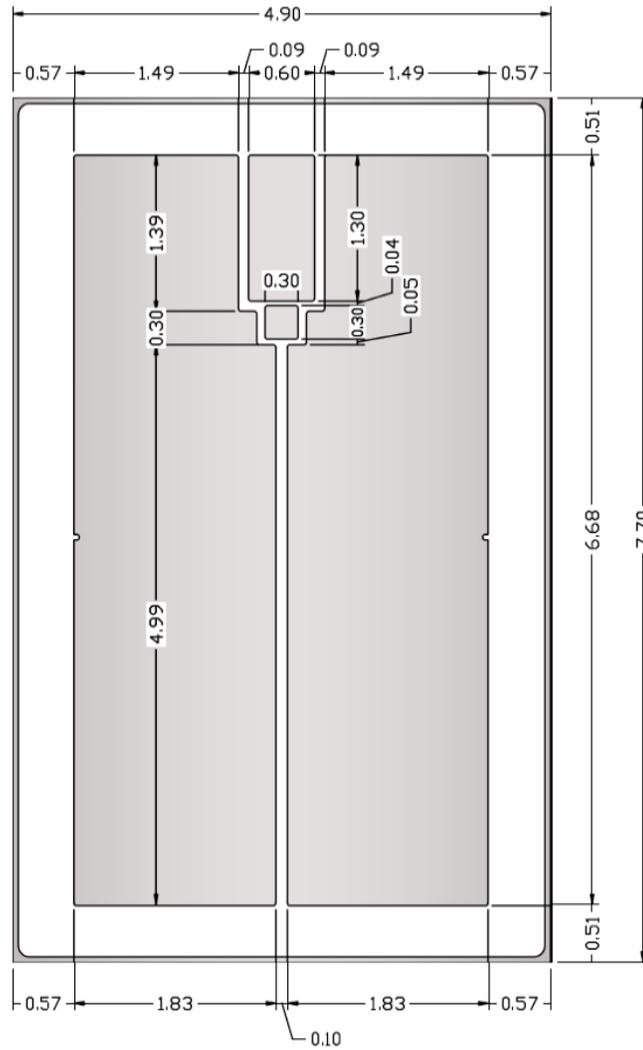
Figure 18.

Capacitances vs. Drain-Source Voltage (0 - 3000 V)



Product Dimensions CPM3-3300-R050A

Die Dimensions (mm)



Not Drawn to Scale

Mechanical Dimensions CPM3-3300-R050A

| Parameter | Typical | Unit |
|--|-------------------|------|
| Die Size (L × W) | 4.90 × 7.70 | mm |
| Exposed Source Pad Metal Dimensions | 1.83 × 6.68 (× 2) | mm |
| Gate Pad Dimensions | 0.6 × 1.3 | mm |
| Chip Thickness ¹ | 400 ± 40 | µm |
| Frontside (Source) Metallization (Al) | 4 | µm |
| Frontside (Gate) Metallization (Al) | 4 | µm |
| Backside (Drain) Metallization (Ni/Au) | 0.8 / 0.1 | µm |

¹ SiC wafer thickness



Product Ordering Information

| Order Number | Description | Package |
|---------------------|-------------------------------------|------------------|
| CPM3-3300-R050A-FS6 | 3300V/53mΩ SiC MOSFET G3 IND UV DUR | Bare Die Product |

Revision History

| Revision Number | Date of Change | Brief Summary |
|-----------------|----------------|--------------------|
| 1 | 04/28/2023 | Initial Release. |
| 2 | 09/20/2024 | Disclaimers Update |

Notes & Disclaimers

Rev. 02, 09-2024

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